# onsemi

## ACUROS<sup>®</sup> CQD<sup>®</sup> 1280L GigE eSWIR Camera

### ACUROS-1280-GIGE-004

The ACUROS CQD L-Series extended SWIR (eSWIR) cameras feature large sensor area, low angular dependence and a long working distance for highly divergent emitters and collimated beams. ACUROS cameras deliver high resolution, high dynamic range and very high detectivity imaging from 400 nm to 2000 nm. The L-Series cameras are designed for use exclusively in laser beam diagnostics, laser beam imaging and laser alignment applications by mitigating interference fringing sources.

#### SPECIFICATIONS

#### Parameter Value/Description Sensor ACUROS CQD sensor **Temperature Stabilization** Single-stage thermo-electric cooler Sensor Array Format 1280 x 1024 Resolution 1.31 MP (megapixel) Spectral Band 400-2000 nm Array Size 19.2 mm x 15.4 mm, 24.6 mm diagonal **Pixel Pitch** 15 μm x 15 μm Max Frame Rate at Full Resolution 88 fps (8 bit), 45 fps (10, 12, 14 bit) **Pixel Operability** 99.9% typical, 99.75% min Bit Depth 8, 10, 12, 14 bit selectable Integration Type Snapshot global shutter External TTL Trigger Integration Time 100 µs to 4 s Dynamic Range 65 dB typical Windowing & Windowing Frame Array centered. Scales inversely to window size Rate Laser Beam Fringeless Operation Yes **Binning Arrays** 2 x 2, 4 x 4 Non-uniformity Correction 2-point non-uniformity correction **Temporal Dark Noise** 80/70/65 e- typical See typical QE curve (Figure 4) Quantum Efficiency

#### Table 1. ELECTRO-OPTICAL SPECIFICATIONS



#### **ORDERING INFORMATION**

Part Number

ACUROS-1280-GIGE-004

#### Features

- Large Sensor Size
- Short Working Distance for Highly Divergent Beams
- Low Angular Dependence
- Dynamic Range up to 70 dB
- Linear Photoresponse
- 1.2 MP Resolution
- TEC Cooling
- Low Noise
- GigE Vision
- Visible-eSWIR

#### Applications

- Laser beam Diagnostics
- Laser Beam Imaging
- Laser Alignment

#### ACUROS-1280-GIGE-004

#### Table 2. ENVIRONMENTAL & POWER SPECIFICATIONS, TYPICAL PERFORMANCE

| Parameter                  | Value/Description                  |
|----------------------------|------------------------------------|
| Operating Case Temperature | –20 °C to +55 °C                   |
| Power Consumption          | 6.5–12 W depending on TEC settings |
| Power Supply Voltage       | 6–16 V dc. POE not supported       |
| Regulatory Compliance      | CE mark                            |

#### Table 3. MECHANICAL SPECIFICATIONS

| Parameter                 | Value/Description                                    |
|---------------------------|--|
| Dimensions Excluding Lens | 6.1 x 6.1 x 9.8 cm (C-mount)                         |
| Weight Excluding Lens     | 505 grams with (C-mount) adapter                     |
| Lens Mounts               | Standard mount (C-mount). Inquire for other options. |
| Power Connector           | Hirose 12-pin, HR10A-10R-12PB (71)                   |
| Trigger Connector         | BNC  |

#### Table 4. SOFTWARE AND USER INTERFACE

| Parameter                | Value/Description                                     |
|--------------------------|---|
| Software Development Kit | Windows GUI & Pleora eBUS SDK (Linux, Windows, macOS) |
| GenICam Compliance       | Yes   |
| Interface                | GigE Vision   |

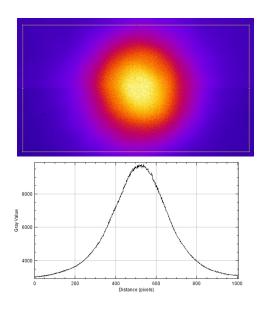


Figure 1. Lens Mount



Figure 2. GiGE Vision Interface

#### ACUROS-1280-GIGE-004



1550 nm Laser image and corresponding line file (false color added post image)

Figure 3. ACUROS CQD SWIR Camera Image of Laser

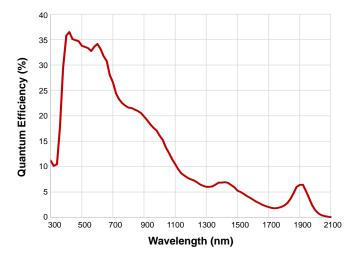


Figure 4. Typical QE Performance

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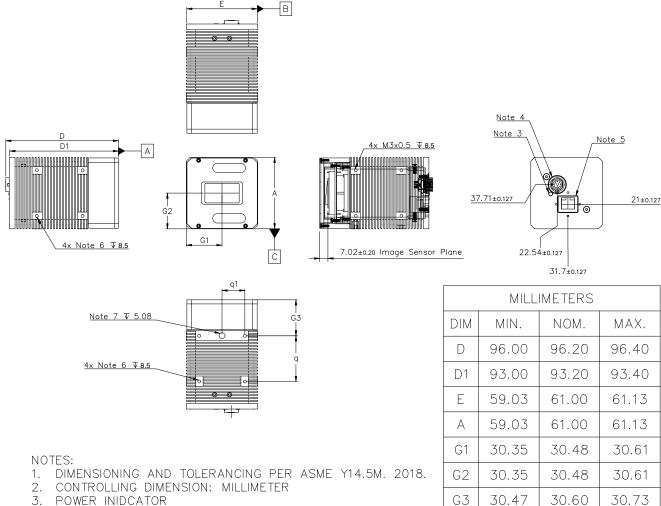
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#### CMOD 96.20x61.00x61.00 CASE 810AD

ISSUE A

DATE 18 NOV 2024



- 4. HIROSE 12 PIN CONNECTOR
- 5. GigE CONNECTOR

**DOCUMENT NUMBER:** 

**DESCRIPTION:** 

- 6. M3X0.5 DEPTH ▼ 8.5.
- 7. 1/4-20 UNC DEPTH ▼ 5.08

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